

Features

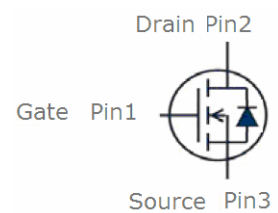
- N-Channel
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5\text{ V}$
- Fast Switching
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant



Part ID	Package Type	Marking	Tape and reel information
VSD100N08MS	TO-252	100N08MS	2500pcs/reel

V_{DS}	80	V
$R_{DS(on),max}$	100	mΩ
I_D	7	A

TO-252



Maximum ratings, at $T_j=25\text{ °C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit	
$V_{(BR)DSS}$	Drain-Source breakdown voltage	80	V	
I_D	Continuous drain current @ $V_{GS}=10\text{V}$	$T_C=25\text{°C}$	7	A
		$T_C=100\text{°C}$	4.2	A
I_{DM}	Pulse drain current tested ①	$T_C=25\text{°C}$	28	A
EAS	Avalanche energy, single pulsed ②	$I_D=6\text{A}$	5.4	mJ
IAS	Avalanche energy, single pulsed ②		6	A
P_D	Maximum power dissipation	$T_C=25\text{°C}$	19.2	W
V_{GS}	Gate-Source voltage	±25	V	
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	°C	

Thermal characteristics

$R_{\theta JC}$	Thermal Resistance-Junction to Case Max.	6.5	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient Max.	85	°C/W

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	80	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _c =25°C)	V _{DS} =64V, V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T _c =125°C)	V _{DS} =64V, V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±25V, V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1	1.7	3	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =10V, I _D =6A	--	85	100	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =4.5V, I _D =3A	--	100	130	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	--	440	--	pF
C _{oss}	Output Capacitance		--	210	--	pF
C _{rss}	Reverse Transfer Capacitance		--	75	--	pF
Q _g	Total Gate Charge	V _{DS} =40V, I _D =4A, V _{GS} =10V	--	11	--	nC
Q _{gs}	Gate-Source Charge		--	3.5	--	nC
Q _{gd}	Gate-Drain Charge		--	6	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =40V, I _D =4A, R _G =6.8Ω, V _{GS} =10V	--	9	--	nS
t _r	Turn-on Rise Time		--	12	--	nS
t _{d(off)}	Turn-Off Delay Time		--	22	--	nS
t _f	Turn-Off Fall Time		--	21	--	nS
Source- Drain Diode Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	I _{SD} =6A, V _{GS} =0V	--	0.88	1.2	V
t _{rr}	Reverse Recovery Time	T _j =25°C, I _{sd} =4A, V _{GS} =0V	--	13	--	nS
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs		9		nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.3mH, R_G = 25Ω, I_{AS} = 6A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

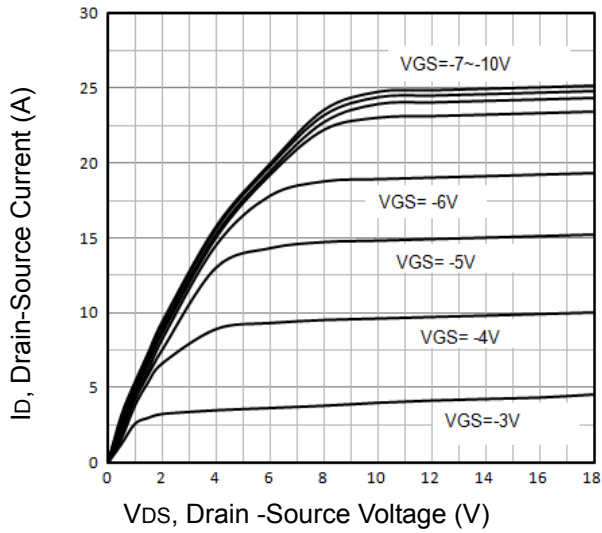


Fig1. Typical Output Characteristics

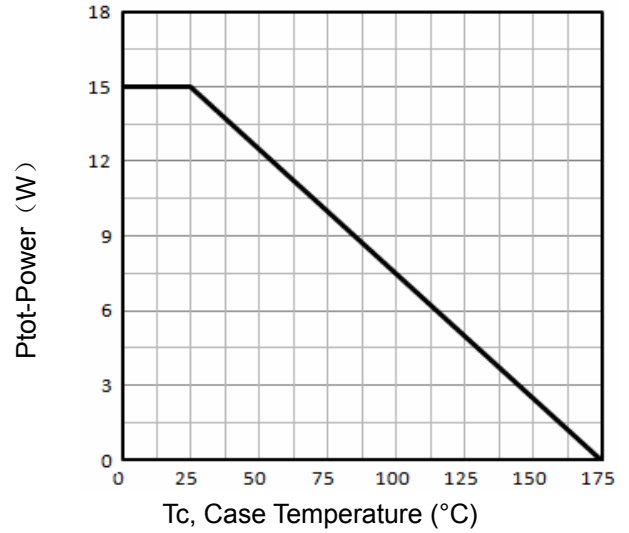


Fig2. Power Dissipation

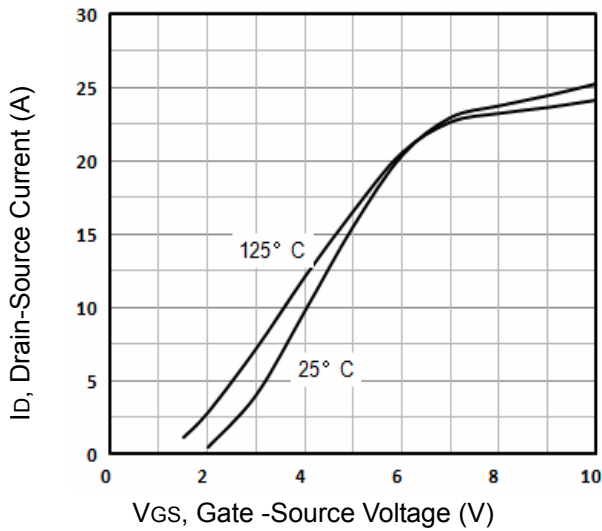


Fig3. Typical Transfer Characteristics

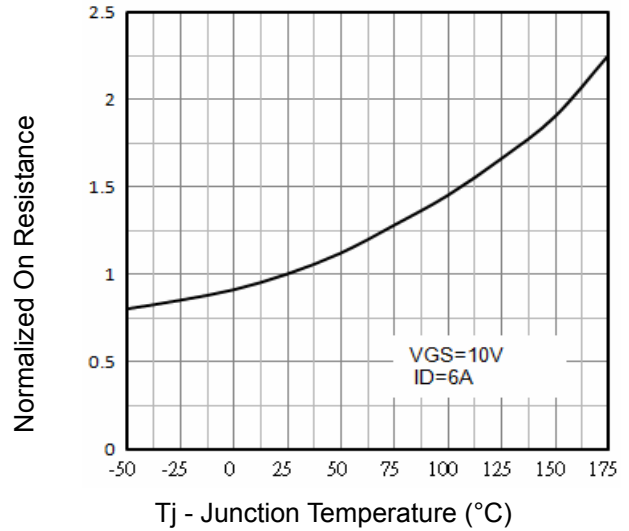


Fig4. Normalized On-Resistance Vs. Temperature

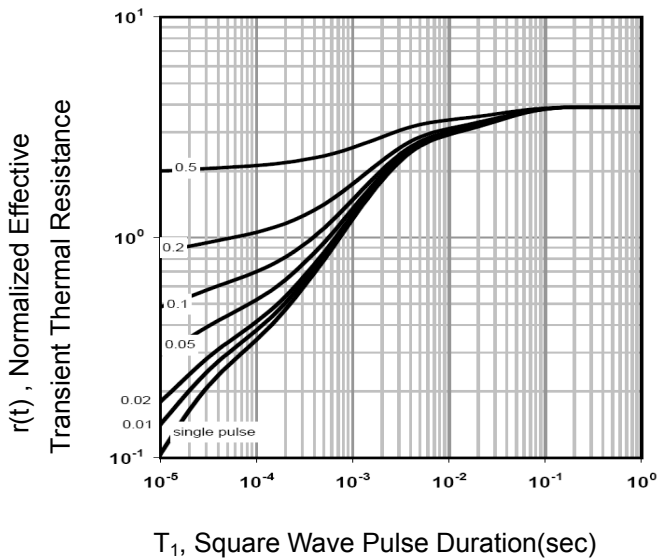


Fig5. T1, Transient Thermal Response Curve

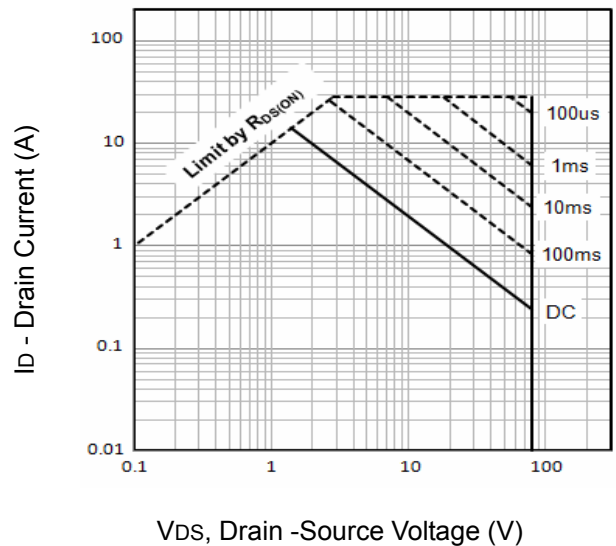


Fig6. Maximum Safe Operating Area

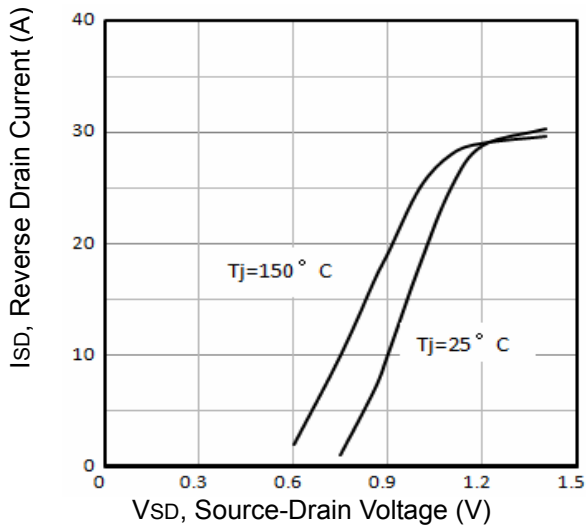


Fig7. Typical Source-Drain Diode Forward Voltage

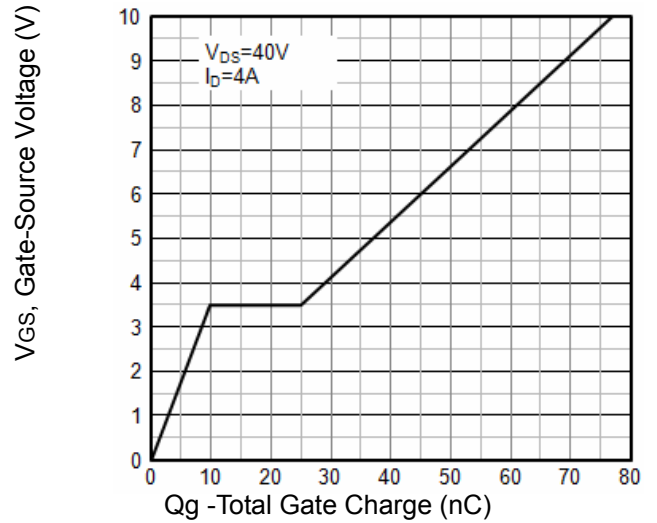


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

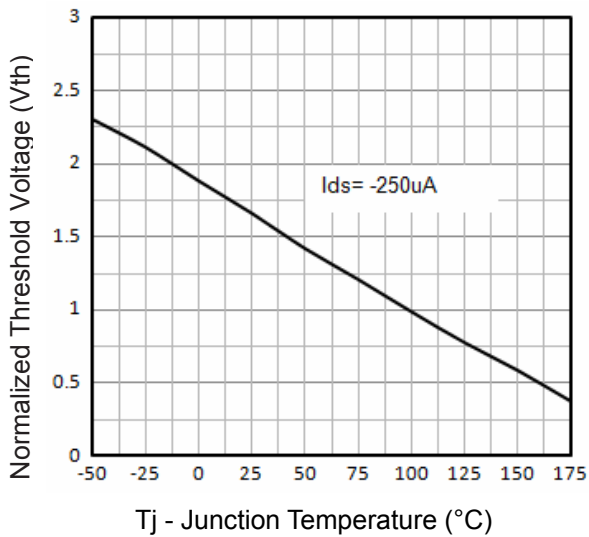


Fig9. Normalized Threshold Voltage Vs. Temperature

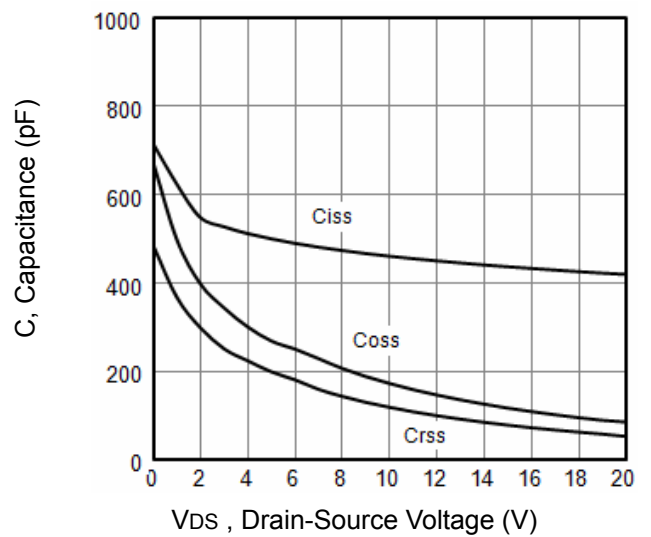


Fig10. Typical Capacitance Vs. Drain-Source Voltage

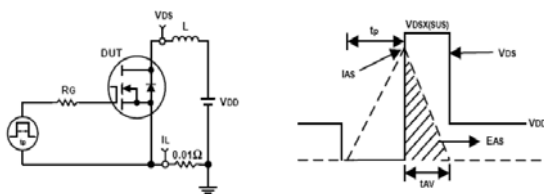


Fig11. Unclamped Inductive Test Circuit and waveforms

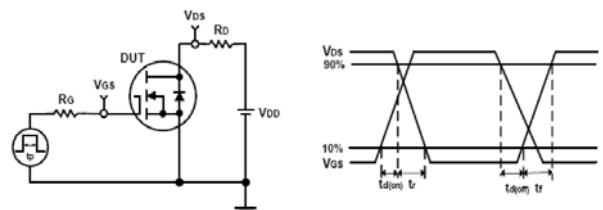
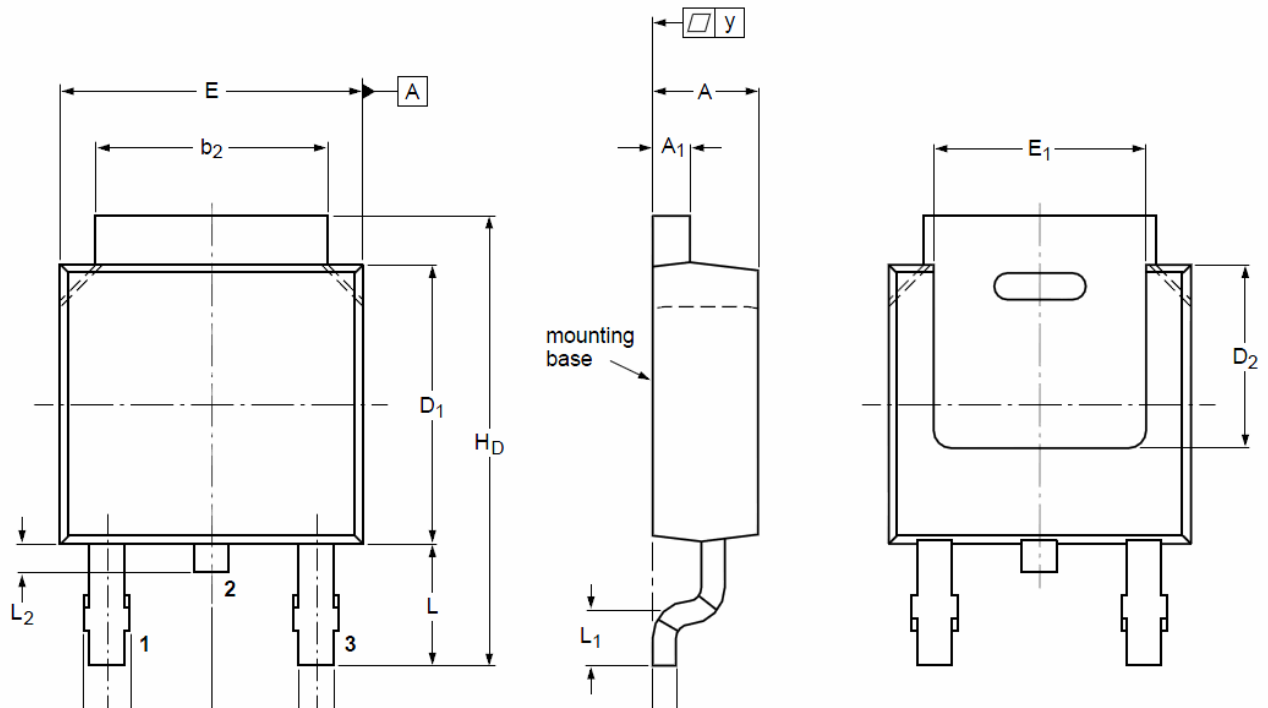


Fig12. Switching Time Test Circuit and waveforms

TO-252 Package Outline



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	2.22	2.30	2.38	A ₁	0.46	0.58	0.93
b	0.71	0.79	0.89	b ₁	0.90	0.98	1.10
b ₂	5.00	5.30	5.46	c	0.20	0.40	0.56
D ₁	5.98	6.05	6.22	D ₂	--	4.00	--
E	6.47	6.60	6.73	E ₁	5.10	5.28	5.45
e	--	2.28	--	e ₁	--	4.57	--
H _D	9.60	10.08	10.40	L	2.75	2.95	3.05
L ₁	--	0.50	--	L ₂	0.80	0.90	1.10
w	--	0.20	--	y	0.20	--	--

Customer Service

Sales and Service:

sales@vgsemi.com

Vanguard Semiconductor CO., LTD

TEL: (86-755) -26902410

FAX: (86-755) -26907027

WEB: www.vgsemi.com